#### Welcome to <u>E-XFL.COM</u>

### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

## Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

## Details

Product Status	Obsolete				
Core Processor	PIC				
Core Size	8-Bit				
Speed	4MHz				
Connectivity	I <sup>2</sup> C, SPI, UART/USART				
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT				
Number of I/O	22				
Program Memory Size	7KB (4K x 14)				
Program Memory Type	ОТР				
EEPROM Size	-				
RAM Size	192 x 8				
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V				
Data Converters	A/D 5x8b				
Oscillator Type	External				
Operating Temperature	-40°C ~ 85°C (TA)				
Mounting Type	Surface Mount				
Package / Case	28-VQFN Exposed Pad				
Supplier Device Package	28-QFN (6x6)				
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc73bt-04i-ml				

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



# PIC16C63A/65B/73B/74B

## PIC16C63A/65B/73B/74B Data Sheet Errata

The PIC16C63A/65B/73B/74B parts you have received conform functionally to the Device Data Sheet (DS30605**C**), except for the anomalies described below.

None.

# Clarifications/Corrections to the Data Sheet:

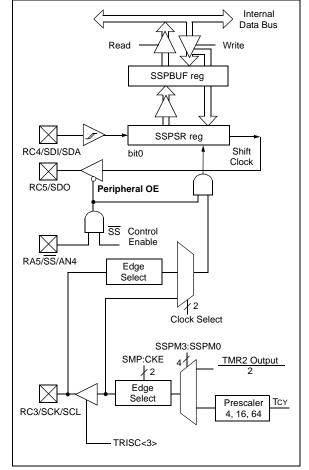
In the Device Data Sheet (DS30605**C**), the following clarifications and corrections should be noted.

## 1. Module: SSP (SPI<sup>™</sup> Mode)

In Section 10.2 ("SPI Mode"), Figure 10-1 and the note box immediately beneath it have been amended to better demonstrate the Peripheral OE line of the SSP module and describe its relationship to the TRISC<5> bit of PORTC.

Changes are indicated in **bold**.





- Note 1: When the SPI module is in Slave mode with SS pin control enabled (SSPCON<3:0> = 0100), the SPI module will reset if the SS pin is set to VDD.
  - **2:** If the SPI is used in Slave mode with CKE = '1', then  $\overline{SS}$  pin control must be enabled.
  - 3: When the SPI is in Slave mode with  $\overline{SS}$ pin control enabled (<u>SS</u>PCON<3:0> = 0100), the state of the SS pin can affect the state read back from the TRISC<5> bit. The Peripheral OE signal from the SSP module into PORTC, controls the state that is read back from the TRISC<5> bit (see Section 5.3 for information on PORTC). If Read-Modify-Write instructions, such as BSF, are performed on the TRISC register while the SS pin is high, this will cause the TRISC<5> bit to be set, thus disabling the SDO output.

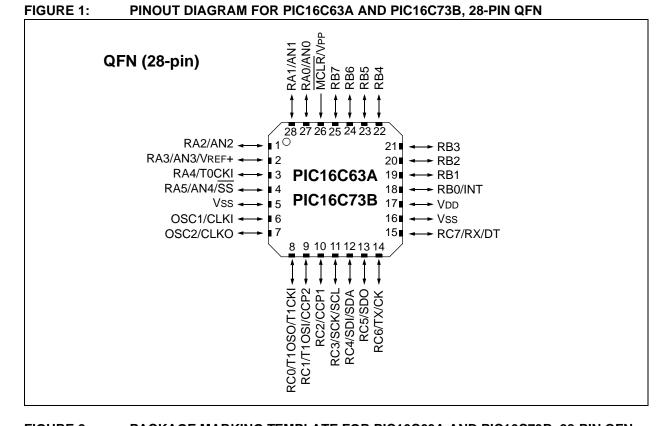
## 2. Module: Packaging (Pinout and Product Identification)

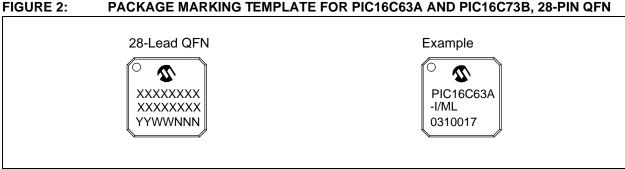
PIC16C63A and PIC16C73B devices are now offered in 28-pin near chip-scale micro lead frame packages (commonly known as "QFN"). This packaging type has been added to the product line since the latest revision of the Device Data Sheet.

The addition of this option requires the following additions to the Device Data Sheet. The referenced figures and tables follow this text.

1. The "Pin Diagram" on page 2 of the Data Sheet is amended with the addition of the 28-pin QFN pinout, shown in Figure 1.

- 2. Table 3-1 of Section 3.0 ("Architectural Overview") is replaced with an updated version that adds a column for QFN pin assignments. All new information is indicated in **bold**.
- 3. Section 18.1 ("Package Marking Information") is amended to include a marking template and example for 28-pin QFN devices. These are shown in Figure 2.
- 4. Section 18.0 ("Package Information") is amended to include the mechanical drawings of the 28-pin QFN package. These are shown in Figure 3 and Figure 4, respectively.
- 5. Table B-1 ("Device Differences") is amended to include the 28-pin QFN for the PIC16C63A and PIC16C73B devices.





Pin Name	DIP Pin#	SOIC Pin#	QFN Pin#	I/O/P Type	Buffer Type	Description
OSC1/CLKIN	9	9	6	I	ST/CMOS <sup>(3)</sup>	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	10	10	7	0	_	Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, the OSC2 pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
MCLR/Vpp	1	1	26	I/P	ST	Master clear (RESET) input or programming voltage input. This pin is an active low RESET to the device.
						PORTA is a bidirectional I/O port.
RA0/AN0 <sup>(4)</sup>	2	2	27	I/O	TTL	RA0 can also be analog input 0 <sup>(4)</sup> .
RA1/AN1 <sup>(4)</sup>	3	3	28	I/O	TTL	RA1 can also be analog input 1 <sup>(4)</sup> .
RA2/AN2 <sup>(4)</sup>	4	4	1	I/O	TTL	RA2 can also be analog input 2 <sup>(4)</sup> .
RA3/AN3/VREF <sup>(4)</sup>	5	5	2	I/O	TTL	RA3 can also be analog input 3 or analog reference voltage <sup>(4)</sup> .
RA4/T0CKI	6	6	3	I/O	ST	RA4 can also be the clock input to the Timer0 module. Output is open drain type.
RA5/SS/AN4 <sup>(4)</sup>	7	7	4	I/O	TTL	RA5 can also be analog input 4 <sup>(4)</sup> or the slave select for the synchronous serial port.
						PORTB is a bidirectional I/O port. PORTB can be software
						programmed for internal weak pull-up on all inputs.
RB0/INT	21	21	18	I/O	TTL/ST <sup>(1)</sup>	RB0 can also be the external interrupt pin.
RB1	22	22	19	I/O	TTL	
RB2	23	23	20	I/O	TTL	
RB3	24	24	21	I/O	TTL	
RB4	25	25	22	I/O	TTL	Interrupt-on-change pin.
RB5	26	26	23	I/O	TTL	Interrupt-on-change pin.
RB6	27	27	24	I/O	TTL/ST <sup>(2)</sup>	Interrupt-on-change pin. Serial programming clock.
RB7	28	28	25	I/O	TTL/ST <sup>(2)</sup>	Interrupt-on-change pin. Serial programming data.
						PORTC is a bidirectional I/O port.
RC0/T1OSO/T1CKI	11	11	8	I/O	ST	RC0 can also be the Timer1 oscillator output or Timer1 clock input.
RC1/T1OSI/CCP2	12	12	9	I/O	ST	RC1 can also be the Timer1 oscillator input or Capture2 input/Compare2 output/PWM2 output.
RC2/CCP1	13	13	10	I/O	ST	RC2 can also be the Capture1 input/Compare1 output/PWM1 output.
RC3/SCK/SCL	14	14	11	I/O	ST	RC3 can also be the synchronous serial clock input/outpu for both SPI and I <sup>2</sup> C modes.
RC4/SDI/SDA	15	15	12	I/O	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O ( $I^2$ C mode).
RC5/SDO	16	16	13	I/O	ST	RC5 can also be the SPI Data Out (SPI mode).
RC6/TX/CK	17	17	14	I/O	ST	RC6 can also be the USART Asynchronous Transmit or Synchronous Clock.
RC7/RX/DT	18	18	15	I/O	ST	RC7 can also be the USART Asynchronous Receive or Synchronous Data.
Vss	8, 19	8, 19	16	Р	-	Ground reference for logic and I/O pins.
Vdd	20	20	17	Р	_	Positive supply for logic and I/O pins.
Legend: I = input		O = out	out	1/0	= input/output	P = power

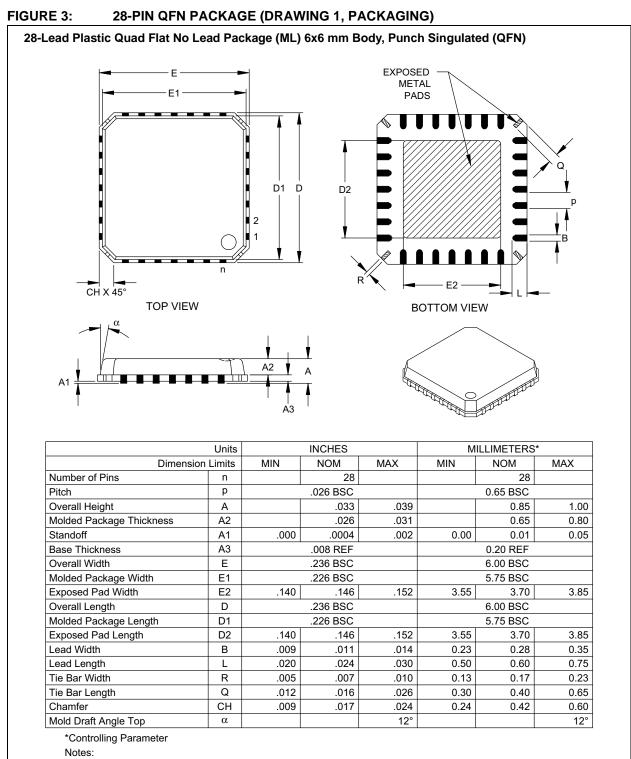
## TABLE 3-1:PIC16C63A/73B PINOUT DESCRIPTION

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.

**2:** This buffer is a Schmitt Trigger input when used in Serial Programming mode.

3: This buffer is a Schmitt Trigger input when configured in RC Oscillator mode and a CMOS input otherwise.

4: A/D module is not available in the PIC16C63A.

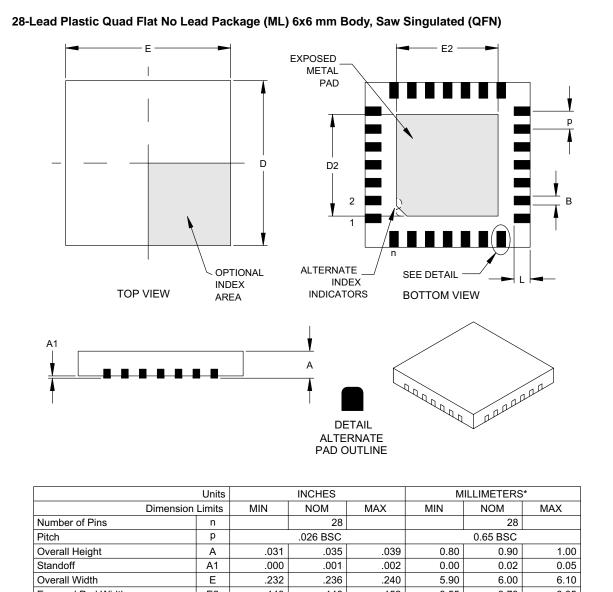


Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC equivalent: mMO-220

Drawing No. C04-114

## PIC16C63A/65B/73B/74B

#### FIGURE 4: 28-PIN QFN PACKAGE (DRAWING 2, PACKAGING)



Exposed Pad Width E2 .140 .146 .152 3.55 3.70 3.85 **Overall Length** D .232 .236 .240 5.90 6.00 6.10 Exposed Pad Length D2 .140 .146 .152 3.55 3.70 3.85 Lead Width В .009 .011 .013 0.23 0.28 0.33 Lead Length L .020 .022 .024 0.50 0.55 0.60

\*Controlling Parameter Notes: JEDEC equivalent: mMO-220 Drawing No. C04-105

## 3. Module: RESET

Section 13.4.1 ("POWER-ON RESET (POR)") has been amended to clarify the minimum specifications required for MCLR in order to RESET the PIC16CXXX. The following paragraphs and figure have been added:

If a  $\overline{\text{MCLR}}$  pulse occurs that is less that the minimum specification (parameter #30), improper device operation can occur.

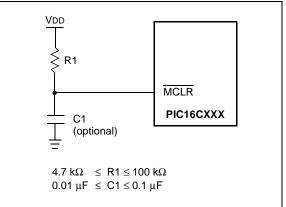
If the minimum specification cannot be met, then an external circuit must be used to ensure that any pulse width less than the <u>specification</u> will be filtered before it reaches the MCLR pin.

A possible circuit to remedy this is shown in Figure 5. This circuit works by delaying the MCLR release following a power-up. If no delay is required, the capacitor may be omitted.

An alternative would be to use a supervisory circuit to control MCLR.

Design validation should be performed to verify that the application works as expected.

## FIGURE 5: MCLR EXTERNAL CIRCUIT



## **REVISION HISTORY**

Rev A Document (7/2003) First revision of this document. Device Data Sheet Clarification issues 1 (SSP), 2 (Packaging) and 3 (RESET).

#### Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is intended through suggestion only and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. No representation or warranty is given and no liability is assumed by Microchip Technology Incorporated with respect to the accuracy or use of such information, or infringement of patents or other intellectual property rights arising from such use or otherwise. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip. No licenses are conveyed, implicitly or otherwise, under any intellectual property rights.

#### Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, KEELOQ, MPLAB, PIC, PICmicro, PICSTART, PRO MATE and PowerSmart are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

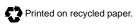
FilterLab, microID, MXDEV, MXLAB, PICMASTER, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Accuron, Application Maestro, dsPICDEM, dsPICDEM.net, ECONOMONITOR, FanSense, FlexROM, fuzzyLAB, In-Circuit Serial Programming, ICSP, ICEPIC, microPort, Migratable Memory, MPASM, MPLIB, MPLINK, MPSIM, PICC, PICkit, PICDEM, PICDEM.net, PowerCal, PowerInfo, PowerMate, PowerTool, rfLAB, rfPIC, Select Mode, SmartSensor, SmartShunt, SmartTel and Total Endurance are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

Serialized Quick Turn Programming (SQTP) is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2003, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.



Microchip received QS-9000 quality system certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona in July 1999 and Mountain View, California in March 2002. The Company's quality system processes and procedures are QS-9000 compliant for its PICmicro® 8-bit MCUS, KEEL 00® code hopping devices, Serial EEPROMs, microperipherals, non-volatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001 certified.





## WORLDWIDE SALES AND SERVICE

### AMERICAS

**Corporate Office** 

2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7270 Fax: 480-792-7277 Technical Support: 480-792-7627 Web Address: http://www.microchip.com

#### Atlanta

3780 Mansell Road, Suite 130 Alpharetta, GA 30022 Tel: 770-640-0034 Fax: 770-640-0307

#### Boston

2 Lan Drive, Suite 120 Westford, MA 01886 Tel: 978-692-3848 Fax: 978-692-3821

#### Chicago

333 Pierce Road, Suite 180 Itasca, IL 60143 Tel: 630-285-0071 Fax: 630-285-0075

#### Dallas

4570 Westgrove Drive, Suite 160 Addison, TX 75001 Tel: 972-818-7423 Fax: 972-818-2924

#### Detroit

Tri-Atria Office Building 32255 Northwestern Highway, Suite 190 Farmington Hills, MI 48334 Tel: 248-538-2250 Fax: 248-538-2260

#### Kokomo

2767 S. Albright Road Kokomo, IN 46902 Tel: 765-864-8360 Fax: 765-864-8387

Los Angeles 18201 Von Karman, Suite 1090 Irvine, CA 92612 Tel: 949-263-1888 Fax: 949-263-1338

Phoenix 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7966 Fax: 480-792-4338

#### San Jose

2107 North First Street, Suite 590 San Jose, CA 95131 Tel: 408-436-7950 Fax: 408-436-7955

#### Toronto

6285 Northam Drive, Suite 108 Mississauga, Ontario L4V 1X5, Canada Tel: 905-673-0699 Fax: 905-673-6509

#### ASIA/PACIFIC

Australia Suite 22, 41 Rawson Street Epping 2121, NSW Australia Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing

Unit 915 Bei Hai Wan Tai Bldg. No. 6 Chaoyangmen Beidajie Beijing, 100027, No. China Tel: 86-10-85282100 Fax: 86-10-85282104

## China - Chengdu

Rm. 2401-2402, 24th Floor, Ming Xing Financial Tower No. 88 TIDU Street Chengdu 610016, China Tel: 86-28-86766200 Fax: 86-28-86766599

China - Fuzhou Unit 28F, World Trade Plaza

No. 71 Wusi Road Fuzhou 350001, China Tel: 86-591-7503506 Fax: 86-591-7503521

China - Hong Kong SAR Unit 901-6, Tower 2, Metroplaza 223 Hing Fong Road Kwai Fong, N.T., Hong Kong Tel: 852-2401-1200 Fax: 852-2401-3431

#### China - Shanghai

Room 701, Bldg. B Far East International Plaza No. 317 Xian Xia Road Shanghai, 200051 Tel: 86-21-6275-5700 Fax: 86-21-6275-5060 **China - Shenzhen** 

China - Shenzhen

Rm. 1812, 18/F, Building A, United Plaza No. 5022 Binhe Road, Futian District Shenzhen 518033, China Tel: 86-755-82901380 Fax: 86-755-8295-1393 **China - Shunde** 

Room 401, Hongjian Building

No. 2 Fengxiangnan Road, Ronggui Town Shunde City, Guangdong 528303, China Tel: 86-765-8395507 Fax: 86-765-8395571

## China - Qingdao

Rm. B505A, Fullhope Plaza, No. 12 Hong Kong Central Rd. Qingdao 266071, China Tel: 86-532-5027355 Fax: 86-532-5027205 **India** Divyasree Chambers 1 Floor, Wing A (A3/A4) No. 11, O'Shaugnessey Road Bangalore, 560 025, India Tel: 91-80-2290061 Fax: 91-80-2290062 **Japan** Benex S-1 6F 3-18-20, Shinyokohama Kohoku-Ku, Yokohama-shi Kanagawa, 222-0033, Japan Tel: 81-45-471- 6166 Fax: 81-45-471-6122

#### Korea

168-1, Youngbo Bldg. 3 Floor Samsung-Dong, Kangnam-Ku Seoul, Korea 135-882 Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934 Singapore 200 Middle Road #07-02 Prime Centre Singapore, 188980 Tel: 65-6334-8870 Fax: 65-6334-8850 Taiwan Kaohsiung Branch 30F - 1 No. 8 Min Chuan 2nd Road Kaohsiung 806, Taiwan Tel: 886-7-536-4818 Fax: 886-7-536-4803 Taiwan Taiwan Branch 11F-3, No. 207 Tung Hua North Road Taipei, 105, Taiwan Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

### EUROPE

Austria Durisolstrasse 2 A-4600 Wels Austria Tel: 43-7242-2244-399 Fax: 43-7242-2244-393 Denmark **Regus Business Centre** Lautrup hoj 1-3 Ballerup DK-2750 Denmark Tel: 45-4420-9895 Fax: 45-4420-9910 France Parc d'Activite du Moulin de Massy 43 Rue du Saule Trapu Batiment A - ler Etage 91300 Massy, France

Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

#### Germany Steinbailetroop

Steinheilstrasse 10 D-85737 Ismaning, Germany Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

### Italy

Via Quasimodo, 12 20025 Legnano (MI) Milan, Italy

Tel: 39-0331-742611 Fax: 39-0331-466781

## Netherlands

P. A. De Biesbosch 14 NL-5152 SC Drunen, Netherlands Tel: 31-416-690399 Fax: 31-416-690340 **United Kingdom** 505 Eskdale Road Winnersh Triangle

Wokingham Berkshire, England RG41 5TU Tel: 44-118-921-5869 Fax: 44-118-921-5820

07/28/03